

MICRON_NOR QLHP, QLJP, QLKP, QLLP LBGA SDP 11x13x1.4 64b (Non-Automotive) Assembly Site Addition of OSE Taiwan

PCN: 34894

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Туре:	Manufacturing Site - Change or Addition						
Description:	Micron is adding assembly site, OSE Taiwan for QLHP, QLJP, QLKP, QLLP LBGA SDP 11x13x1.4 64b non-automotive products Site Locations: Current: (ATX SH) ATX Semiconductor Co,Ltd. China / Shanghai, No.669, Guoshoujing Road, Zhangjiang Hi-Tech Park, Pudong New Area, Shanghai 201203, P.R.C Future: (ATX SH) ATX Semiconductor Co,Ltd China / Shanghai, No.669, Guoshoujing Road, Zhangjiang Hi-Tech Park, Pudong New Area, Shanghai 201203, P.R.C						
				(OSE) - Semiconductor Group Manufacturing, No. 80, Jing 3rd Rd., Nanzih Dist., Kaohsiung 811, Taiwan (R.O.C.)			
				Reason:	Supply Flexibility/Security		
				Product Affected:	QLHP, QLJP, QLKP, QLLP LBGA SDP 11x13x1.4 64b products		
				Affected Micron Part Number		Recommended Replacement	Customer Part Number
				COMPONENT			777 1002 0 N/D
	MT28EW01GABA1HPC-0SIT MT28EW01GABA1LPC-0SIT			557-1993-2-ND			
MT28EW128ABA1HPC-0SIT			557-1777-ND				
MT28EW128ABA1LPC-0SIT			557-1779-ND				
MT28EW256ABA1HPC-0SIT			557-1780-ND				
MT28EW256ABA1LPC-0SIT			557-1782-ND				
MT28EW512ABA1HPC-0SIT			MT28EW512ABA1HPC-0SIT-NI				
MT28EW512ABA1LPC-0SIT			557-1783-ND				
		*Materials that have been ordered are in I	bold.				
Method of Identification:	Master shipping container label will indicate country of origin from China to Taiwan.						
Micron Sites Affected:	Subcontractor						
Sample Available:	2023-02-28						

Product Ship Date: 2023-05-29

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NOTE: Per JEDEC Standard J-STD-046 Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

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Attachments

There are no attachments on this PCN